

Title (en)
INSULATING FILM

Title (de)
ISOLIERFOLIE

Title (fr)
FILM ISOLANT

Publication
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Application
EP 17836645 A 20170627

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Abstract (en)
[origin: EP3493223A1] An insulating film of the present invention includes a resin formed of polyimide, polyamide-imide, or a mixture thereof, and ceramic particles having a specific surface area of 10 m/g or more, in which the ceramic particles form aggregated particles and a content of the ceramic particles is in a range of 5 vol% or more and 60 vol% or less.

IPC 8 full level
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Citation (search report)
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• [X] US 2014234617 A1 20140821 - MASAKI SHUNSUKE [JP], et al
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EP 3493223 A1 20190605; **EP 3493223 A4 20200325**; CN 109155165 A 20190104; CN 109155165 B 20210518; JP 2018026320 A 20180215; TW 201811882 A 20180401; TW I718315 B 20210211; US 11124673 B2 20210921; US 2019144706 A1 20190516

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